

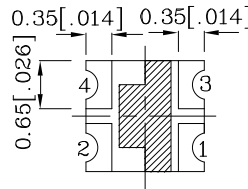
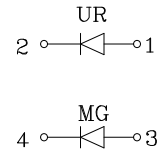
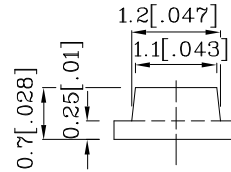
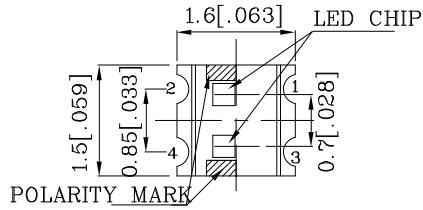
Features

- 1.6mmx1.5mm SMT LED, 0.7mm THICKNESS.
- LOW POWER CONSUMPTION.
- WIDE VIEWING ANGLE.
- IDEAL FOR BACKLIGHT AND INDICATOR.
- VARIOUS COLORS AND LENS TYPES AVAILABLE.
- PACKAGE : 2000PCS / REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 3.
- RoHS COMPLIANT.



Notes:

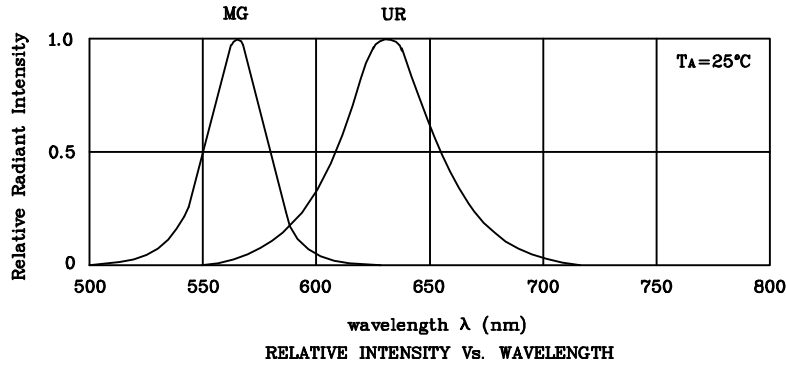
1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.2(0.008)$ unless otherwise noted.
3. Specifications are subject to change without notice.



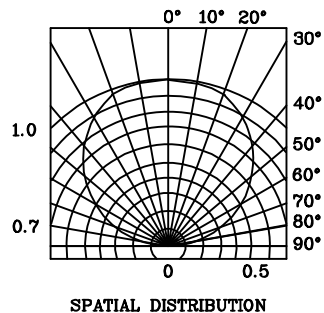
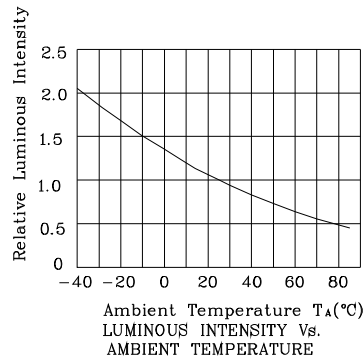
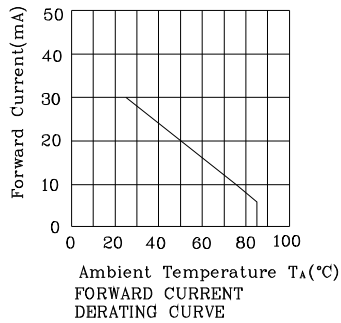
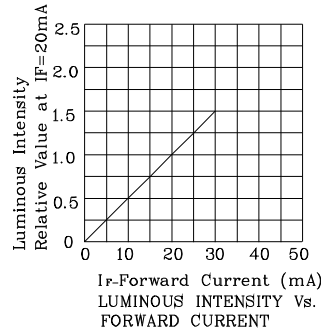
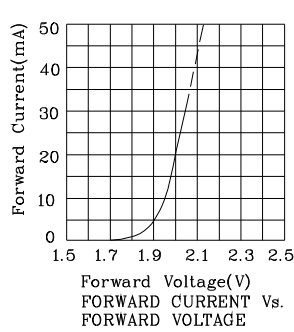
Absolute Maximum Ratings (TA=25°C)		UR (GaAsP/ GaP)	MG (GaP)	Unit
Reverse Voltage	V _R	5	5	V
Forward Current	I _F	30	25	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	i _{FS}	160	140	mA
Power Dissipation	P _T	75	62.5	mW
Operating Temperature	T _A	-40 ~ +85		°C
Storage Temperature	T _{stg}	-40 ~ +85		

Operating Characteristics (TA=25°C)		UR (GaAsP/ GaP)	MG (GaP)	Unit
Forward Voltage (Typ.) (I _F =20mA)	V _F	2.0	2.2	V
Forward Voltage (Max.) (I _F =20mA)	V _F	2.5	2.5	V
Reverse Current (Max.) (V _R =5V)	I _R	10	10	µA
Wavelength of Peak Emission (Typ.) (I _F =20mA)	λ _P	627	565	nm
Wavelength of Dominant Emission (Typ.) (I _F =20mA)	λ _D	625	568	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	Δλ	45	30	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	C	15	15	pF

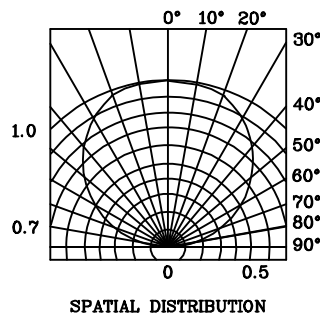
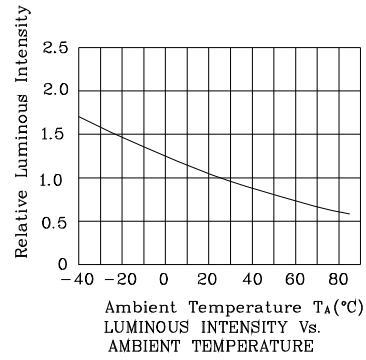
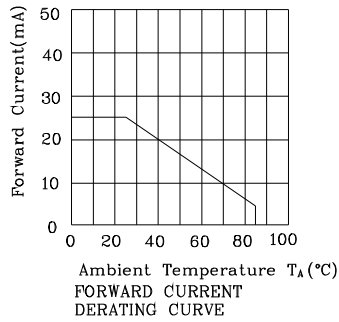
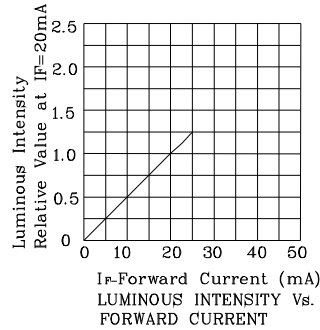
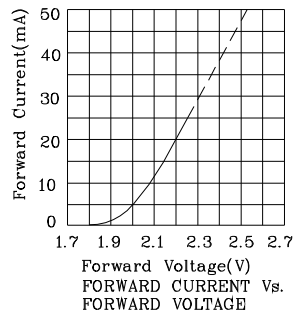
Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (I _F =20mA) mcd		Wavelength nm λ _P	Viewing Angle 2 θ 1/2
				min.	typ.		
XZURMG59W-1	Red	GaAsP/GaP	Water Clear	4	11	627	120°
	Green	GaP		4	11	565	



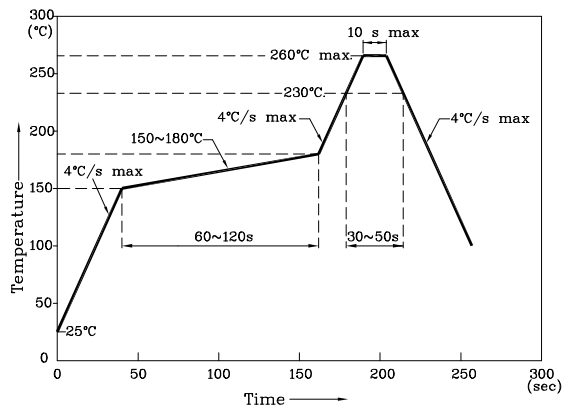
❖ UR



❖ MG



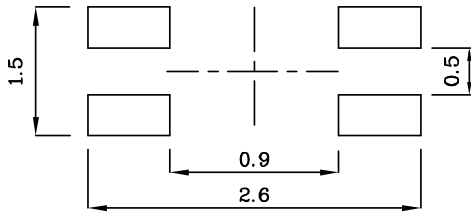
Reflow Soldering Profile For Lead-free SMT Process.



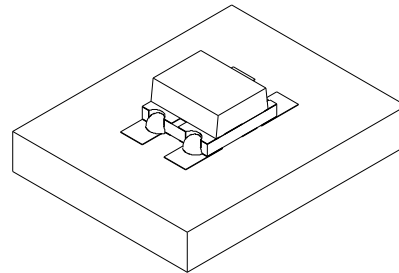
NOTES:

1. Maximum soldering temperature should not exceed 260°C.
2. Recommended reflow temperature: 145°C–260°C.
3. Do not put stress to the epoxy resin during high temperatures conditions.

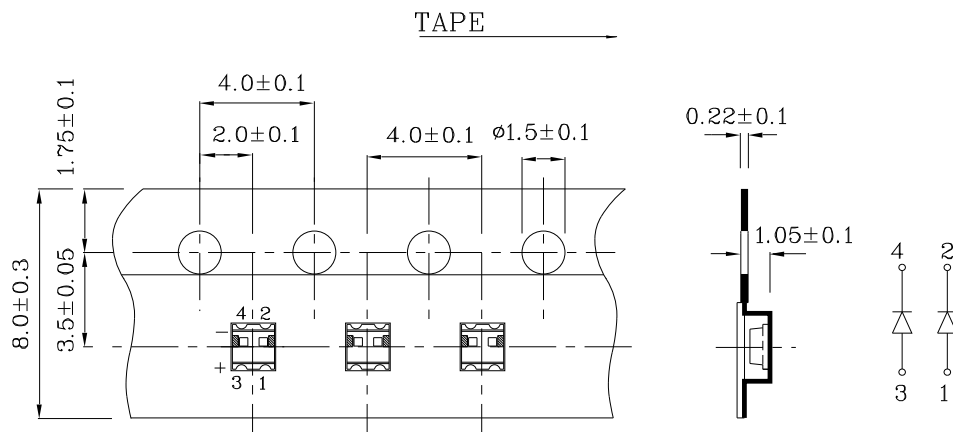
❖ Recommended Soldering Pattern (Units : mm; Tolerance: ±0.1)



❖ The device has a single mounting surface. The device must be mounted according to the specifications.



❖ Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

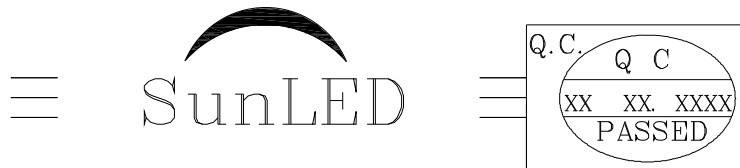
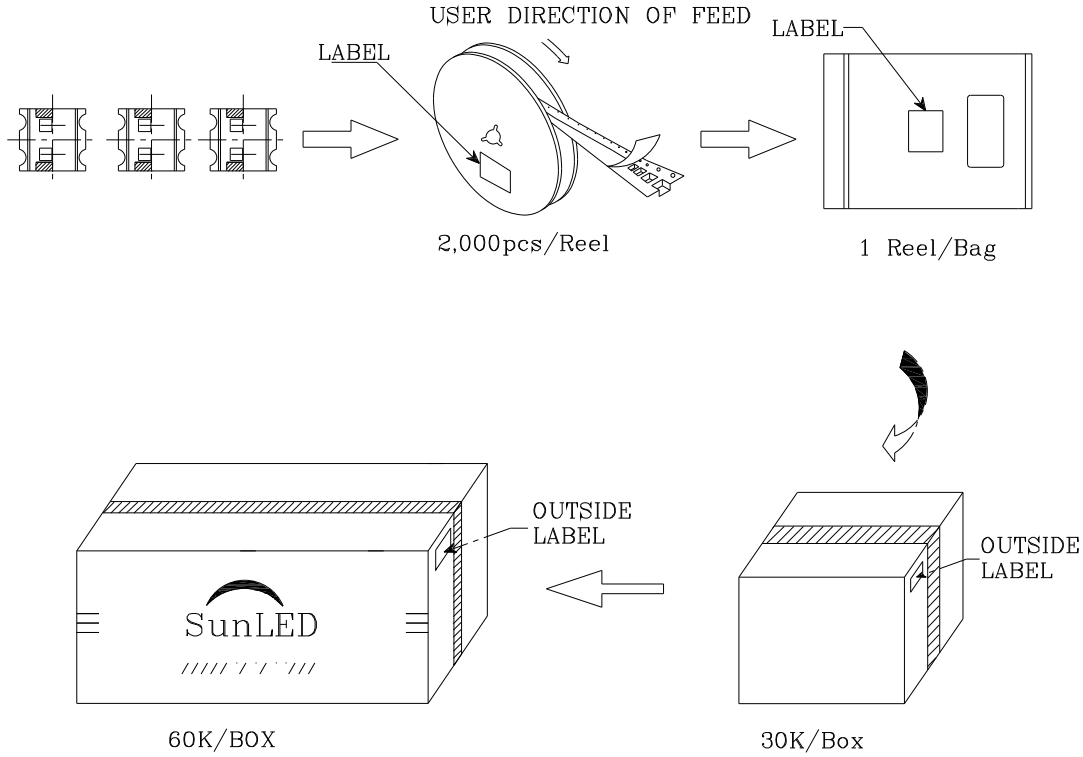
1. Wavelength: +/-1nm
2. Luminous Intensity / Luminous Flux: +/-15%
3. Forward Voltage: +/-0.1V


Note: Accuracy may depend on the sorting parameters.



PACKING & LABEL SPECIFICATIONS

XZURMG59W-1



P/NO : XZxxx59x-1	
QTY : 2,000 pcs	CODE: XXX
S/N : XX	
LOT NO :	
 XXXXXXXXXXXXXXXXXXXXXXXXX	
RoHS Compliant	